

SL1021A/B Series



Description

GDT circuit protection devices dissipate electrical surge energy safely within a contained plasma gas. Commonly used to help protect sensitive telecom and networking equipment and lines, GDTs protect from damage that may result from lightning strikes and equipment switching operations.

The Littelfuse GDT series described in this document are available in a variety of leaded and surface mount forms and offered with and without optional fail-safe clip. Please refer to the electrical specifications, dimension and packaging options section of this document for additional information.

SL1021A/B Series:

SL1021A/B series GDTs are designed to offer high levels of performance on fast rising transients in the range of 100V/μS to 1KV/μS, which are those most likely created by induced lightning disturbances.

These devices feature ultra low capacitance (typically 1.5pF or less) and are extremely robust with SL1021A devices able to divert a 10,000 Amp pulse without destruction, and SL1021B suffix devices able to divert a 20,000 Amp pulse without destruction.

These series offer optimized internal geometry which provide low insertion loss at high frequencies, ideal for the protection of broadband and other high speed transmission equipment.

Agency Approvals

AGENCY	AGENCY FILE NUMBER
	E128662

3 Electrode GDT Graphical Symbol



Features

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 10KA (A suffix devices) / 20KA (B suffix devices) surge capability tested with 8/20μs pulse as defined by IEC 61000-4-5
- Available with thermal failsafe option (add 'F' suffix to part number)

Applications

- SL1021:**
- Broadband equipment
 - ADSL equipment
 - XDSL equipment
 - Satellite and CATV equipment
 - Splitters
 - General telecom equipment
 - Telecom network interfaces
 - Telephone line cards
 - Repeaters
 - Modems
 - Line test equipment

Product Characteristics

Materials	Dull Tin Plate 17.5 ± 12.5 Microns. with ceramic insulator
Product Marking	'LF' mark, voltage & date code: SL1021A - Red/White text SL1021B - Blue/White text
Glow to arc transition current	~ 1Amp
Glow Voltage	~60-200 Volts
Storage and Operation Temperature	-40 to +90°C
Transverse Voltage (Delay Time)	< 0.2μSec (Tested to ITU-T Rec. K.12)
Arc Voltage	~10 to 35 Volts
Holdover Voltage	<150mS (Tested to ITU-T Rec. K.12)

Electrical Characteristics

Device Specifications (at 25°C)							Life Ratings						
Part Number	DC Voltage 100V/Sec.			DC Voltage 100 V/ μ Sec.	DC Voltage 1kV/ μ Sec.	Capacitance (@1Mhz)	Insulation Resistance	AC Current 50Hz 1Sec.x10 ¹	Surge Current 8/20 μ Sec x10 ¹	Max Single Surge 8/20 μ Sec ¹	Max Single Surge 10/350 μ Sec ¹	Surge Life 10/1000 μ Secx300 ¹	
	MIN	TYP	MAX										
SL1021B075	60	75	90	500	650	<1.5pF	>10 ¹⁰ Ω (at 50V)	10Amps	10kA ² 20kA ³	15kA ² 25kA ³	4kA ² 5kA ³	200Amps	
SL1021A090 SL1021B090	72	90	108										
SL1021A145 SL1021B145	116	145	174										
SL1021A150 SL1021B150	120	150	180										
SL1021A200	150	200	250										
SL1021A230 SL1021B230	184	230	276		450								
SL1021A250 SL1021B250	200	250	300		500								
SL1021A260 SL1021B260	210	260	310		550		700						
SL1021A300 SL1021B300	240	300	360		650		850				>10 ¹⁰ Ω (at 100V)		
SL1021A350 SL1021B350	280	350	420		700		900						
SL1021A400 SL1021B400	320	400	480		850		950						
SL1021A420 SL1021B420	345	420	500										
SL1021A450 SL1021B450	360	450	540		900		1000						
SL1021A500 SL1021B500	400	500	600		950		1100						
SL1021A600	480	600	720		1000		1200						

NOTES:

- Total current through centre electrode, tested in accordance with ITU-T Rec K.12
- SL1021A series
- SL1021B series

Additional Information



**Datasheet
SL1021A**



**Resources
SL1021A**



**Samples
SL1021A**



**Datasheet
SL1021B**

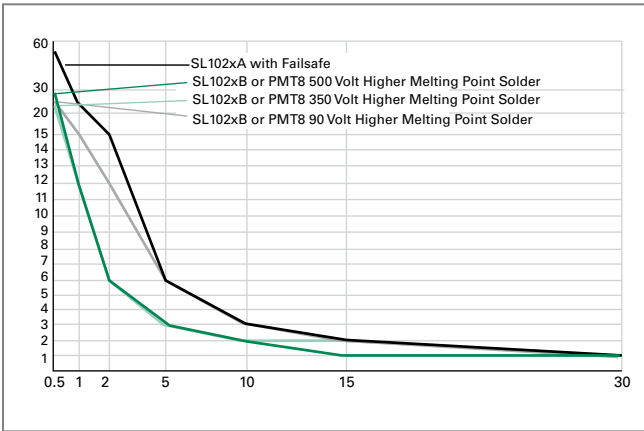


**Resources
SL1021B**



**Samples
SL1021B**

Time vs. Current for Failsafe



Voltage vs. Time Characteristic



Soldering Parameters - Reflow Soldering (Surface Mount Devices)

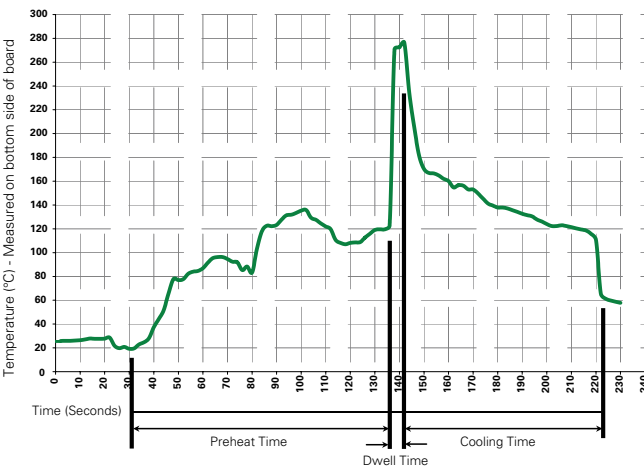
Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (Min to Max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		5°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_l)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		10 – 30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



Soldering Parameters - Hand Soldering

Solder Iron Temperature: 350° C +/- 5°C
Heating Time: 5 seconds max.

Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

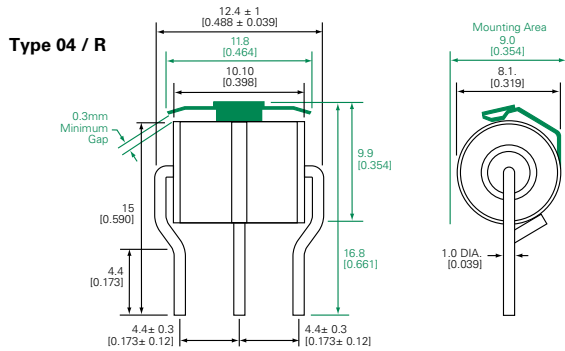
Wave Parameter	Lead-Free Recommendation
Preheat: (Depends on Flux Activation Temperature)	(Typical Industry Recommendation)
Temperature Minimum:	100° C
Temperature Maximum:	150° C
Preheat Time:	60-180 seconds
Solder Pot Temperature:	280° C Maximum
Solder Dwell Time:	2-5 seconds

Note: Surge Arrestors with a Failsafe mechanism should be individually examined after soldering

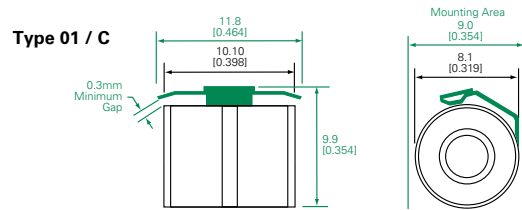
Device Dimensions

NOTE: Failsafe option dimensions shown in green.

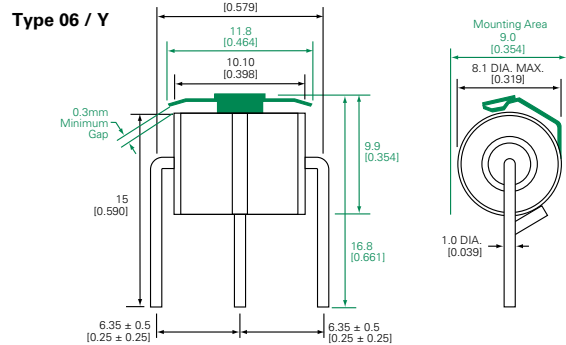
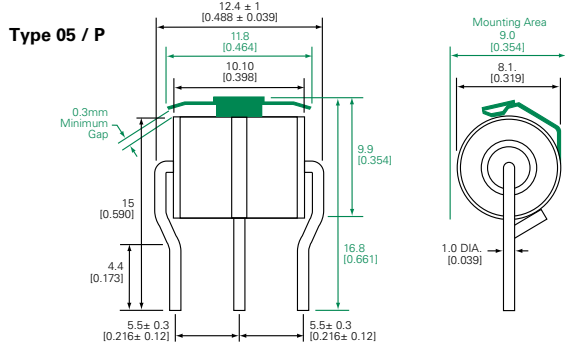
Shaped Radial Leaded Devices:



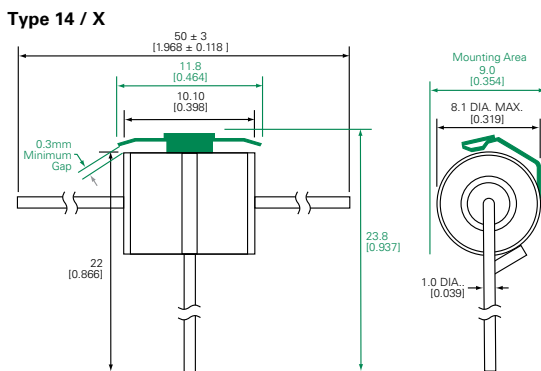
Core Devices:



Straight Radial Leaded Devices:



Straight "T" Leaded Devices:



Type "R" is available for SL1021B075 device only.